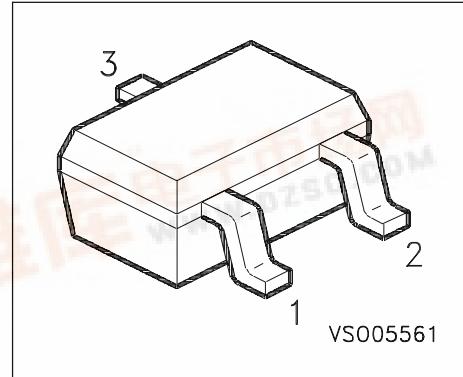




BFT 92W

## PNP Silicon RF Transistor

- For broadband amplifiers up to 2GHz at collector currents up to 20mA
- Complementary type: BFR 92W (NPN)



**ESD:** Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Ordering Code	Pin Configuration			Package
BFT 92W	W1s	Q62702-F1681	1 = B	2 = E	3 = C	SOT-323

### Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	$V_{CEO}$	15	V
Collector-base voltage	$V_{CBO}$	20	
Emitter-base voltage	$V_{EBO}$	2	
Collector current	$I_C$	25	mA
Base current	$I_B$	3	
Total power dissipation $T_S \leq 105^\circ\text{C}$	$P_{tot}$	200	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Ambient temperature	$T_A$	- 65 ... + 150	
Storage temperature	$T_{stg}$	- 65 ... + 150	

### Thermal Resistance

Junction - soldering point 1)	$R_{thJS}$	$\leq 225$	K/W
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1)  $T_S$  is measured on the collector lead at the soldering point to the pcb.

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**DC Characteristics**

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	15	-	-	V
Collector-base cutoff current $V_{CB} = 10 \text{ V}, I_E = 0$	$I_{\text{CBO}}$	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 2 \text{ V}, I_C = 0$	$I_{\text{EBO}}$	-	-	10	µA
DC current gain $I_C = 15 \text{ mA}, V_{CE} = 8 \text{ V}$	$h_{\text{FE}}$	15	50	-	-

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### AC Characteristics

Transition frequency $I_C = 15 \text{ mA}, V_{CE} = 8 \text{ V}, f = 500 \text{ MHz}$	$f_T$	3.5	5	-	GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	0.58	0.9	pF
Collector-emitter capacitance $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{ce}$	-	0.3	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	$C_{eb}$	-	0.77	-	
Noise figure $I_C = 2 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{Sopt}$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	$F$	-	2	-	dB
-	-	-	3.2	-	
Power gain 2) $I_C = 15 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{Sopt}$ $Z_L = Z_{Lopt}$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	$G_{ma}$	-	14	-	
-	-	-	8.5	-	
Transducer gain $I_C = 15 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50 \Omega$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	$ S_{21e} ^2$	-	11.5	-	
-	-	-	6	-	

2)  $G_{ma} = |S_{21}/S_{12}| (k - (k^2 - 1)^{1/2})$

### SPICE Parameters (Gummel-Poon Model, Berkeley-SPICE 2G.6 Syntax) :

#### Transistor Chip Data

IS =	4.5354	fA	BF =	98.533	-	NF =	0.90551	-
VAF =	10.983	V	IKF =	0.016123	A	ISE =	12.196	fA
NE =	1.1172	-	BR =	10.297	-	NR =	1.2703	-
VAR =	47.577	V	IKR =	0.019729	A	ISC =	0.024709	fA
NC =	1.206	-	RB =	7.9562	$\Omega$	IRB =	0.79584	mA
RBM =	1.5939	$\Omega$	RE =	1.5119	$\Omega$	RC =	0.66749	$\Omega$
CJE =	1.7785	fF	VJE =	0.79082	V	MJE =	0.32167	-
TF =	32.171	ps	XTF =	0.30227	-	VTF =	0.21451	V
ITF =	0.013277	mA	PTF =	0	deg	CJC =	922.07	fF
VJC =	1.2	V	MJC =	0.3	-	XCJC =	0.3	-
TR =	2.0779	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	XTB =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.75167	-	TNOM	300	K

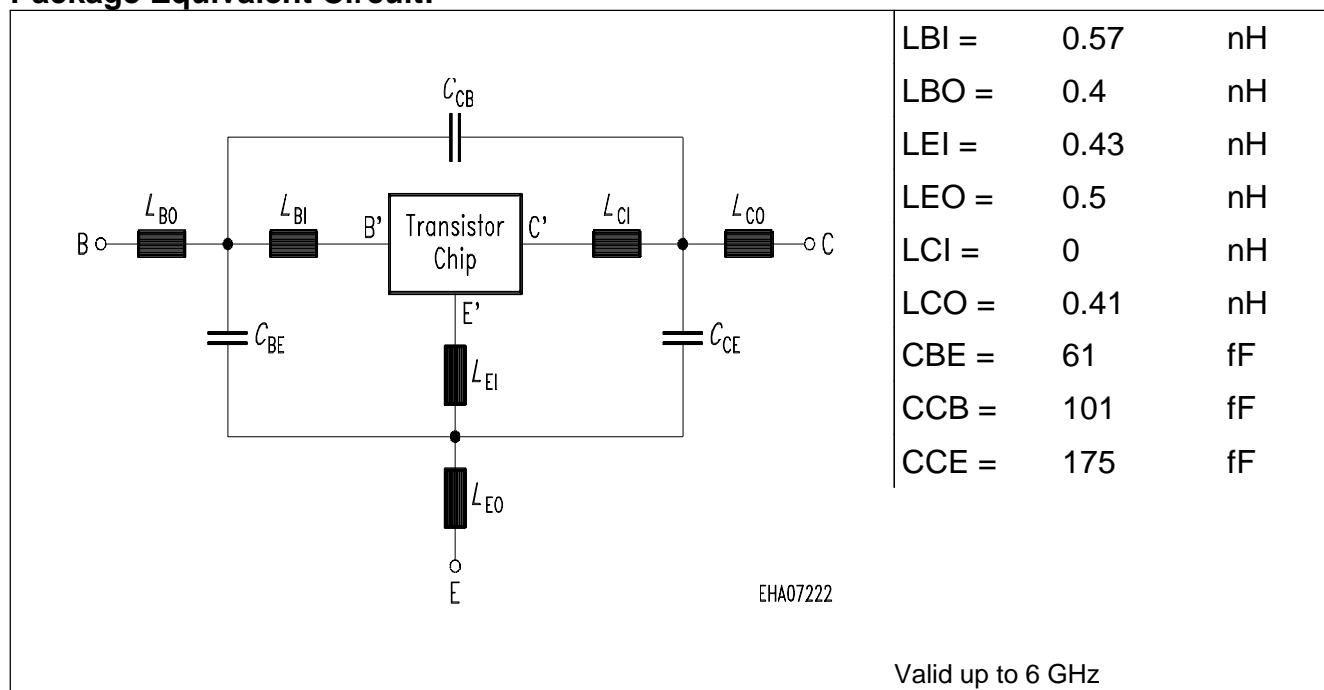
All parameters are ready to use, no scaling is necessary.

Extracted on behalf of SIEMENS Small Signal Semiconductors by:

Institut für Mobil- und Satellitenfunktechnik (IMST)

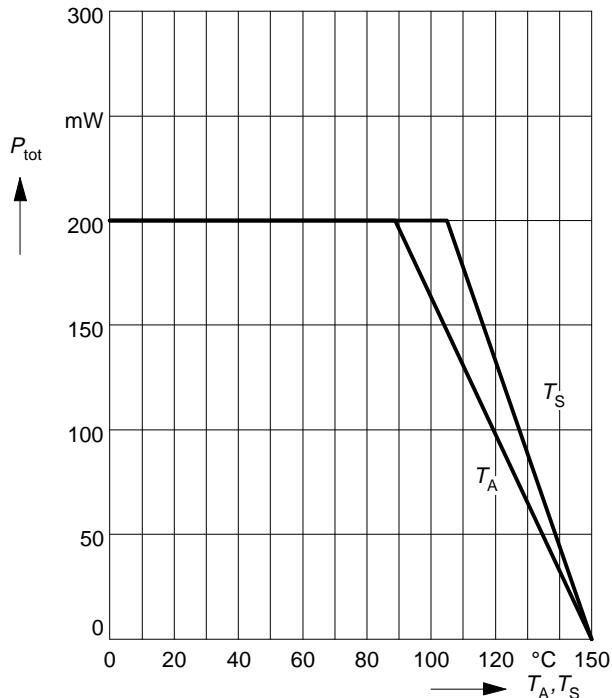
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#### Package Equivalent Circuit:

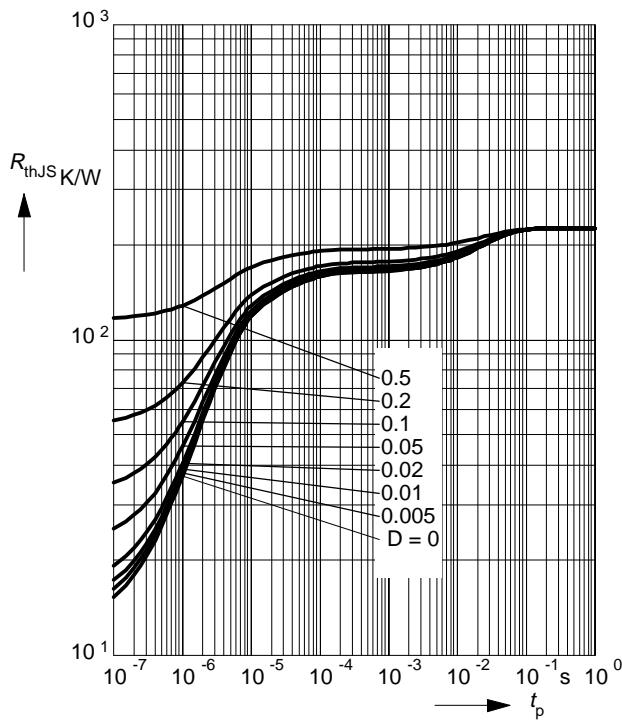


**Total power dissipation**  $P_{\text{tot}} = f(T_A^*, T_S)$

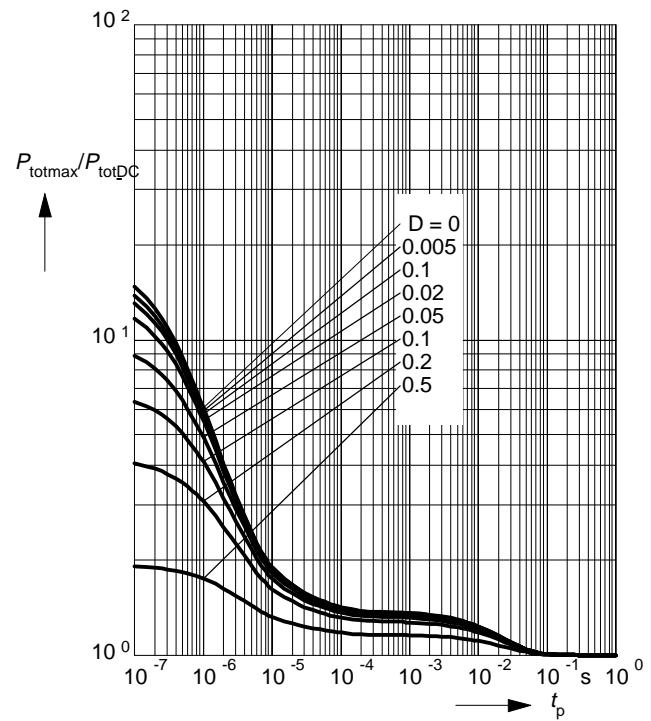
\* Package mounted on epoxy



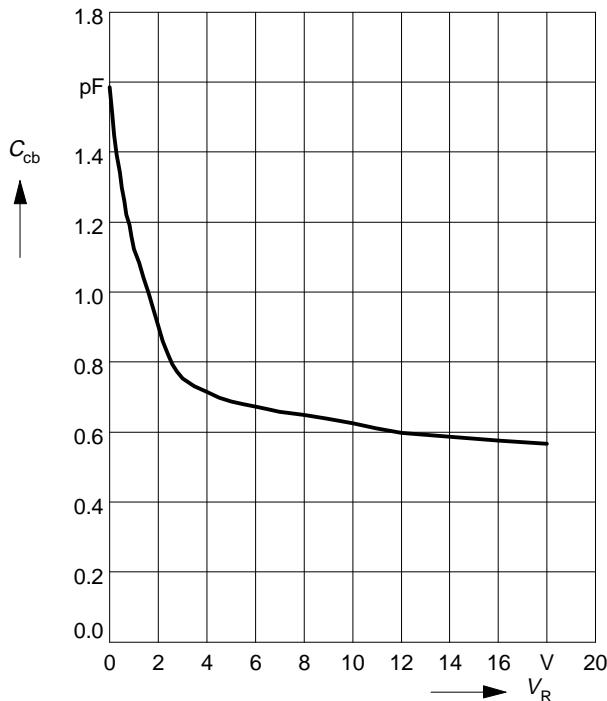
**Permissible Pulse Load**  $R_{\text{thJS}} = f(t_p)$



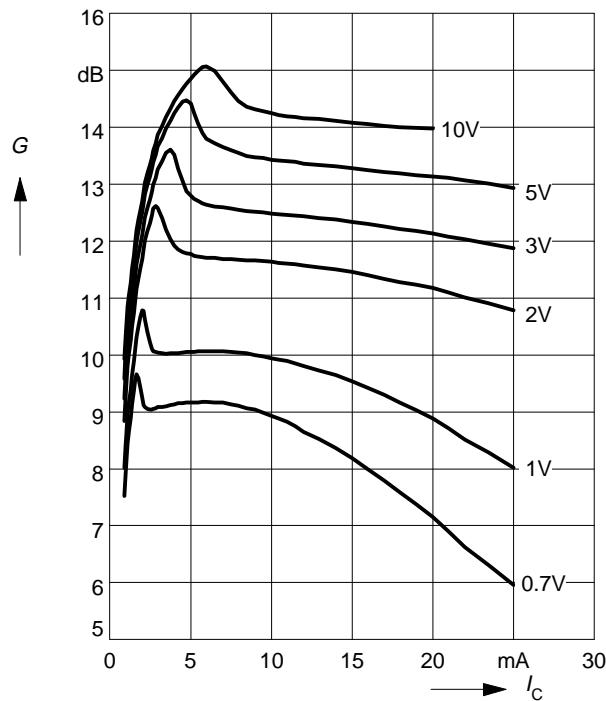
**Permissible Pulse Load**  $P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$



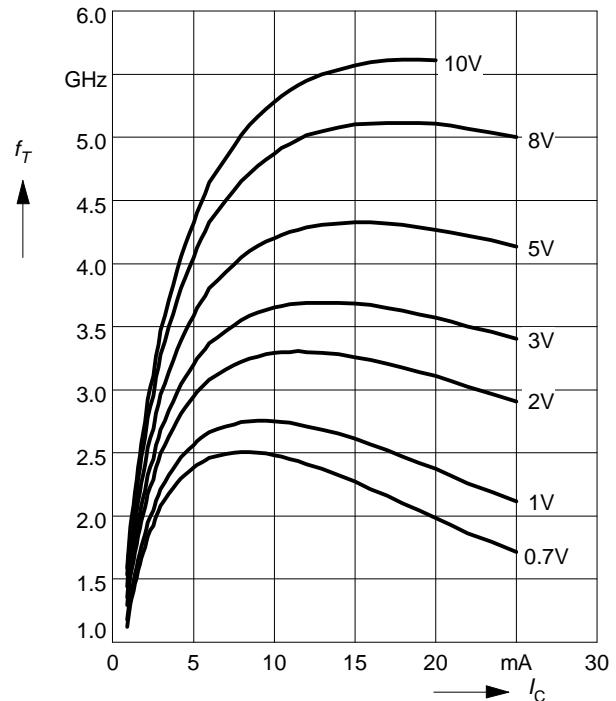
**Collector-base capacitance**  $C_{cb} = f(V_{CB})$   
 $V_{BE} = V_{be} = 0$ ,  $f = 1\text{MHz}$



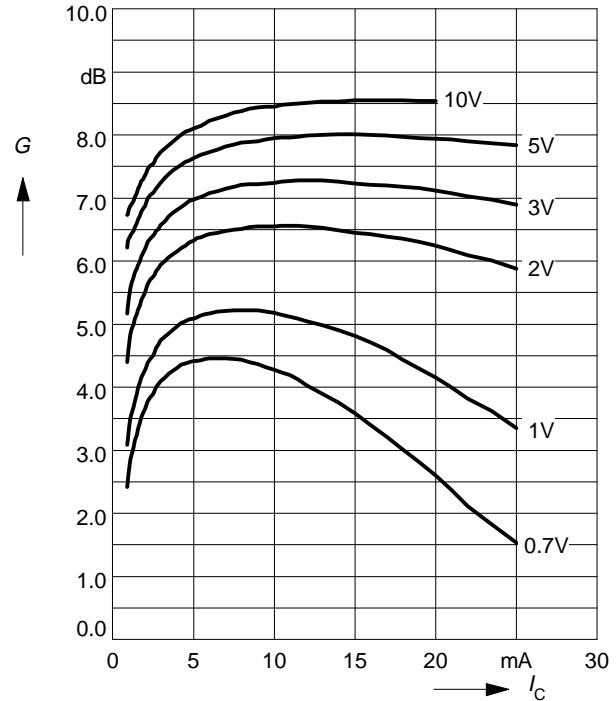
**Power Gain**  $G_{ma}$ ,  $G_{ms} = f(I_C)$   
 $f = 0.9\text{GHz}$   
 $V_{CE}$  = Parameter



**Transition frequency**  $f_T = f(I_C)$   
 $V_{CE}$  = Parameter



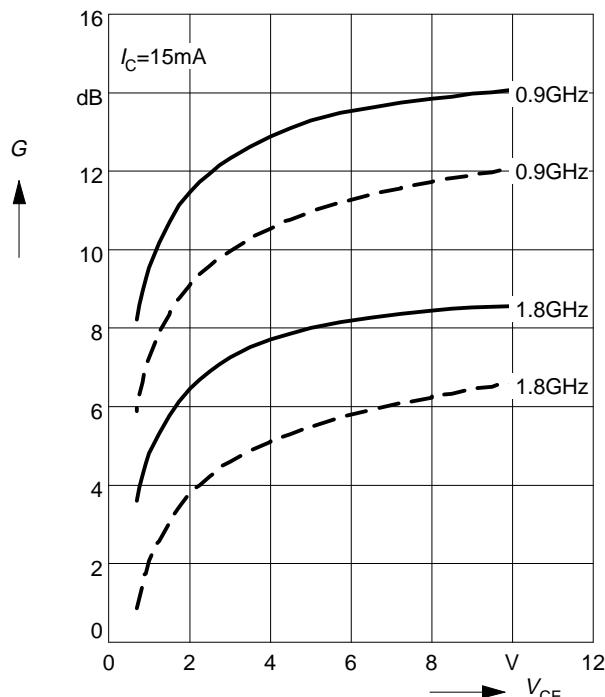
**Power Gain**  $G_{ma}$ ,  $G_{ms} = f(I_C)$   
 $f = 1.8\text{GHz}$   
 $V_{CE}$  = Parameter



**Power Gain**  $G_{\text{ma}}, G_{\text{ms}} = f(V_{\text{CE}})$ : \_\_\_\_\_

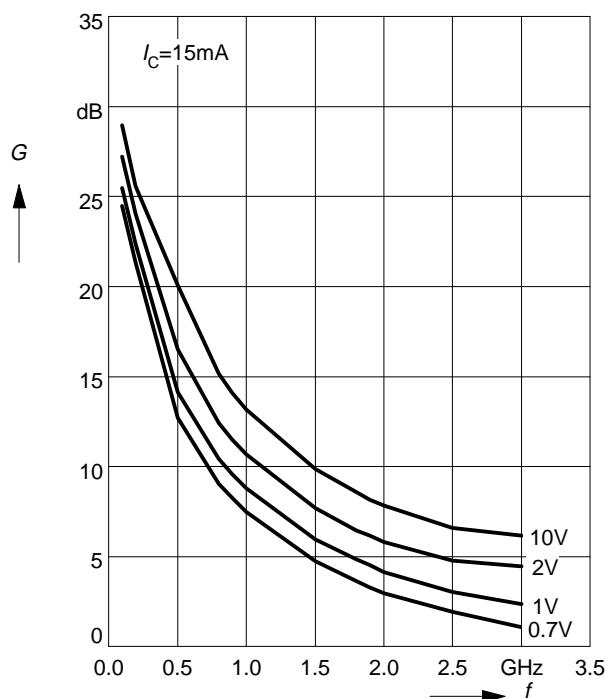
$|S_{21}|^2 = f(V_{\text{CE}})$ : -----

f = Parameter



**Power Gain**  $G_{\text{ma}}, G_{\text{ms}} = f(f)$

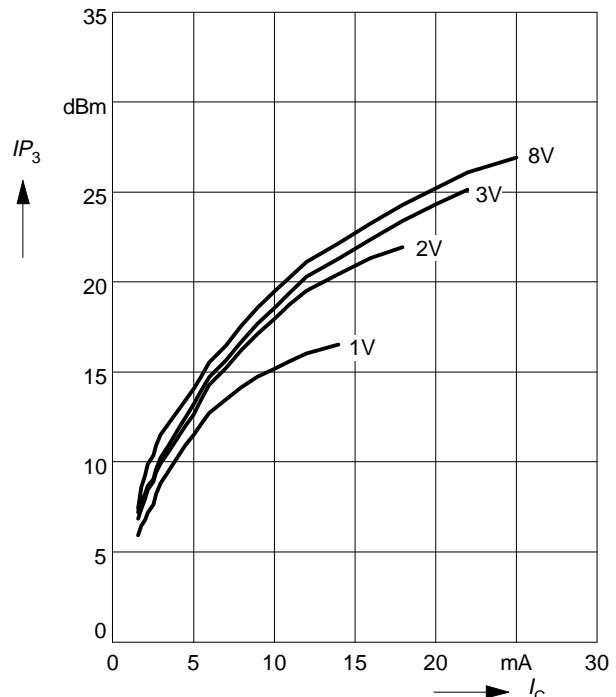
$V_{\text{CE}}$  = Parameter



**Intermodulation Intercept Point**  $IP_3 = f(I_C)$

(3rd order, Output,  $Z_S = Z_L = 50\Omega$ )

$V_{\text{CE}}$  = Parameter,  $f = 900\text{MHz}$



**Power Gain**  $|S_{21}|^2 = f(f)$

$V_{\text{CE}}$  = Parameter

